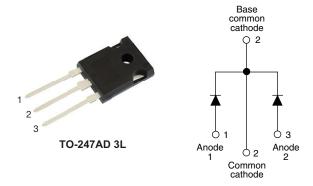


COMPLIANT

HALOGEN FREE

## Ultrafast Soft Recovery Diode, 2 x 30 A FRED Pt® Gen 4



PRIMARY CHARACTERISTICS						
I <sub>F(AV)</sub> 2 x 30 A						
$V_{R}$	600 V					
V <sub>F</sub> at I <sub>F</sub>	1.19 V					
t <sub>rr</sub> typ.	See Recovery table					
T <sub>J</sub> max.	175 °C					
Package	TO-247AD 3L					
Circuit configuration	Common cathode					

### **FEATURES**

- Gen 4 FRED Pt® technology
- Low I<sub>RRM</sub> and reverse recovery charge
- · Very low forward voltage drop
- Polyimide passivated chip for high reliability standard





 Material categorization: for definitions of compliance please see <a href="https://www.vishay.com/doc?99912"><u>www.vishay.com/doc?99912</u></a>

#### **DESCRIPTION**

Gen 4 Fred technology, state of the art, ultralow  $V_F$ , soft switching optimized for Discontinuous (Critical) Mode (DCM) and IGBT F/W diode.

The minimized conduction loss, optimized stored charge and low recovery current minimize the switching losses and reduce power dissipation in the switching element and snubbers.

ABSOLUTE MAXIMUM RATINGS						
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS		
Peak repetitive reverse voltage	$V_{RRM}$		600	V		
Average rectified forward current	I <sub>F(AV)</sub>	T <sub>C</sub> = 131 °C	30	۸		
Non-repetitive peak surge current, per leg	I <sub>FSM</sub>	$T_C = 25$ °C, $t_p = 8.3$ ms, half sine wave	240	А		
Operating junction and storage temperature	T <sub>J</sub> , T <sub>Stg</sub>		-55 to +175	°C		

<b>ELECTRICAL SPECIFICATIONS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	L TEST CONDITIONS MIN. TYP.		MAX.	UNITS			
Breakdown voltage, blocking voltage	$V_{BR}$ , $V_{R}$	I <sub>R</sub> = 100 μA	600	-	-			
		I <sub>F</sub> = 30 A	-	1.36	1.6			
	V <sub>F</sub>	I <sub>F</sub> = 60 A	-	1.6	-	V		
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 125 °C	-	1.23	-			
Forward voltage		I <sub>F</sub> = 60 A, T <sub>J</sub> = 125 °C	-	1.5	-			
		I <sub>F</sub> = 30 A, T <sub>J</sub> = 150 °C	-	1.19	1.35			
		I <sub>F</sub> = 60 A, T <sub>J</sub> = 150 °C	-	1.48	-			
Reverse leakage current	I <sub>R</sub>	V <sub>R</sub> = V <sub>R</sub> rated	-	-	50			
		T <sub>J</sub> = 125 °C, V <sub>R</sub> = V <sub>R</sub> rated	-	-	500	μA		
Junction capacitance	C <sub>T</sub>	V <sub>R</sub> = 600 V	-	18.3	-	pF		



<b>DYNAMIC RECOVERY CHARACTERISTICS</b> (T <sub>J</sub> = 25 °C unless otherwise specified)								
PARAMETER	SYMBOL	MIN.	TYP.	MAX.	UNITS			
Reverse recovery time		T <sub>J</sub> = 25 °C	I <sub>F</sub> = 30 A dI <sub>F</sub> /dt = 1000 A/μs V <sub>R</sub> = 400 V	-	65	-	ns	
	t <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	90	-		
Peak recovery current	I <sub>RRM</sub>	T <sub>J</sub> = 25 °C		-	18	-	۸	
		T <sub>J</sub> = 125 °C		-	32	-	A	
Reverse recovery charge	0	T <sub>J</sub> = 25 °C		-	850	-	nC	
	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C		-	1850	-	nC	

THERMAL - MECHANICAL SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Thermal resistance, junction to case	R <sub>thJC</sub>		-	-	1	°C/W	
Thermal resistance, case to heat sink	R <sub>thCS</sub>		ı	0.4	-		
Weight			1	6.0	-	g	
Weight			ı	0.21	-	oz.	
Mounting torque			6.0		12	kgf · cm	
Modifiling torque			(5)	_	(10)	(lbf $\cdot$ in)	
Marking device		Case style TO-247AD 3L	C4PU3006LH				

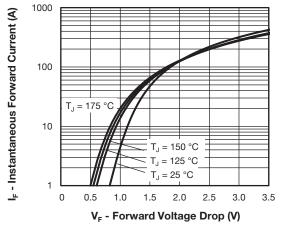


Fig. 1 - Typical Forward Voltage Drop Characteristics

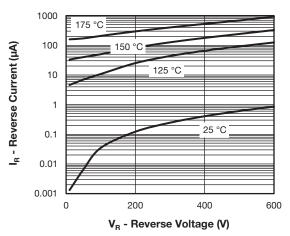


Fig. 2 - Typical Values of Reverse Current vs. Reverse Voltage

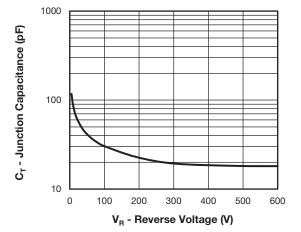


Fig. 3 - Typical Junction Capacitance vs. Reverse Voltage

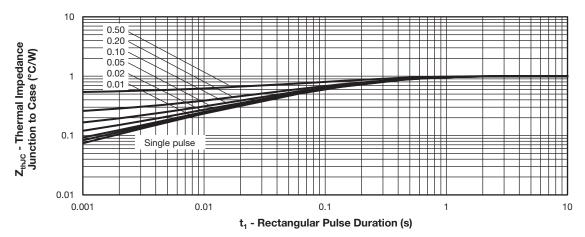


Fig. 4 - Maximum Thermal Impedance Z<sub>thJC</sub> Characteristics

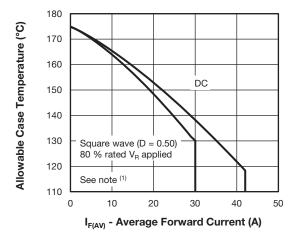


Fig. 5 - Maximum Allowable Case Temperature vs. Average Forward Current

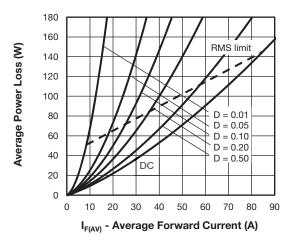


Fig. 6 - Forward Power Loss Characteristics

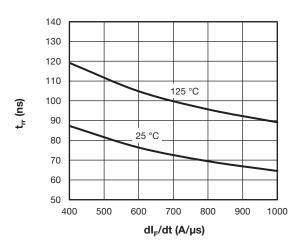


Fig. 7 - Typical Reverse Recovery Time vs.  $dI_F/dt$ 

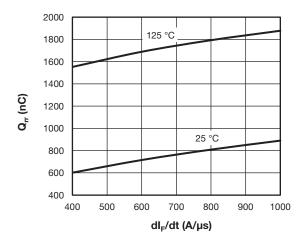


Fig. 8 - Typical Stored Charge vs. dl<sub>F</sub>/dt

### Note

 $\begin{array}{ll} \text{(1)} & \text{Formula used: } T_C = T_J - (P_d + P_{dREV}) \times R_{thJC}; \\ Pd = \text{forward power loss} = I_{F(AV)} \times V_{FM} \text{ at } (I_{F(AV)}/D) \text{ (see Fig.5)} \\ P_{dREV} = \text{inverse power loss} = V_{R1} \times I_R \text{ (1 - D); } I_R \text{ at } V_R = \text{rated } V_R \\ \end{array}$ 

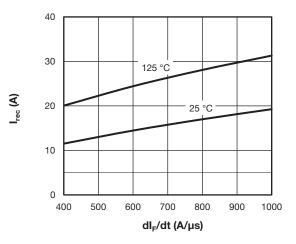
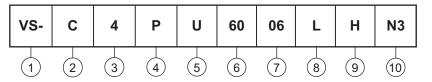


Fig. 9 - Typical Reverse Current vs. dl<sub>F</sub>/dt

### **ORDERING INFORMATION TABLE**

**Device code** 



- 1 Vishay Semiconductors product
- **2** Circuit configuration:

C = common diode

- FRED Pt Gen 4
- P = TO-247 package
- **5** Process type:

U = ultrafast recovery

- 6 Current rating (60 = 2 x 30 A)
- 7 Voltage rating (06 = 600 V)
- 8 Package: L = long lead
- 9 H = AEC-Q101 qualified
- 10 Environmental digit:

N3 = halogen-free, RoHS-compliant, and totally lead (Pb)-free

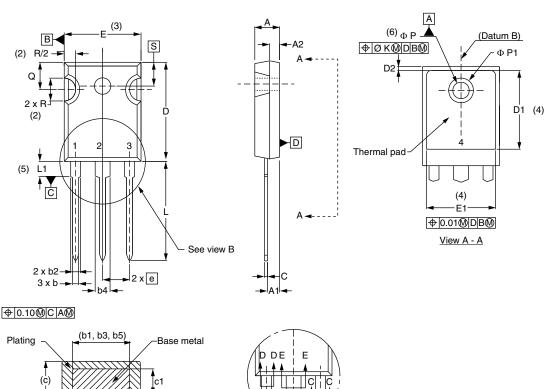
ORDERING INFORMATION (Example)						
PREFERRED P/N	QUANTITY PER TUBE	MINIMUM ORDER QUANTITY	PACKAGING DESCRIPTION			
VS-C4PU6006LHN3	25	500	Antistatic plastic tube			

LINKS TO RELATED DOCUMENTS					
Dimensions	TO-247AD 3L	www.vishay.com/doc?95626			
Part marking information	TO-247AD 3L	www.vishay.com/doc?95007			



## **TO-247AD 3L**

### **DIMENSIONS** in millimeters and inches



Section C - C, D - D, E - E							
SYMBOL	MILLIN	IETERS	INC	HES	NOTES		
STIVIDUL	MIN.	MAX.	MIN.	MAX.	NOTES		
Α	4.65	5.31	0.183	0.209			
A1	2.21	2.59	0.087	0.102			
A2	1.50	2.49	0.059	0.098			
b	0.99	1.40	0.039	0.055			

0.039

0.065

0.065

0.102

0.102

0.015

0.015

0.776

0.515

0.053

0.094

0.092

0.135

0.133

0.035

0.033

0.815

(h h2 h4)

:5	

View B

SYMBOL	POI WILLIWIL I LING INCOMES		NOTES		
STIVIDOL	MIN.	MAX.	MIN.	MAX.	NOTES
D2	0.51	1.30	0.020	0.051	
E	15.29	15.87	0.602	0.625	3
E1	13.46	-	0.53	-	
е	5.46	BSC	0.215	BSC	
ØΚ	0.254		0.0	10	
L	19.81	20.32	0.780	0.800	
L1	3.71	4.29	0.146	0.169	
ØΡ	3.56	3.66	0.14	0.144	
Ø P1	-	6.98	-	0.275	
Q	5.31	5.69	0.209	0.224	
R	4.52	5.49	0.178	0.216	
S	5.51 BSC		0.217 BSC		
•	•				•

INCHES

MILLIMETERS

### Notes

b1

b2

b3

b4

b5

С

с1

D

D1

(1) Dimensioning and tolerancing per ASME Y14.5M-1994

1.35

2.39

2.34

3.43

3.38

0.89

0.84

20.70

- (2) Contour of slot optional
- (3) Dimension D and E do not include mold flash. These dimensions are measured at the outermost extremes of the plastic body

3

- (4) Thermal pad contour optional with dimensions D1 and E1
- (5) Lead finish uncontrolled in L1

0.99

1.65

1.65

2.59

2.59

0.38

0.38

19.71

13.08

- (6) Ø P to have a maximum draft angle of 1.5 to the top of the part with a maximum hole diameter of 3.91 mm (0.154")
- (7) Outline conforms to JEDEC® outline TO-247 with exception of dimension A min., D, E min., Q min., S, and note 4



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